

Features

- 3 Micron Radiation Hardened SOS CMOS
- Total Dose 200K or 1 Mega-RAD (Si)
- Dose Rate Upset >10¹⁰ RAD(Si)/s 20ns Pulse
- Latch-Up Free Under Any Conditions
- Military Temperature Range: -55°C to +125°C
- Significant Power Reduction Compared to LSTTL ICs
- DC Operating Voltage Range: 4.5V to 5.5V
- LSTTL Input Compatibility
 - VIL = 0.8V Max.
 - VIH = VCC/2 Min
- Input Current Levels $I_i \leq 5\mu A$ at VOL, VOH

Description

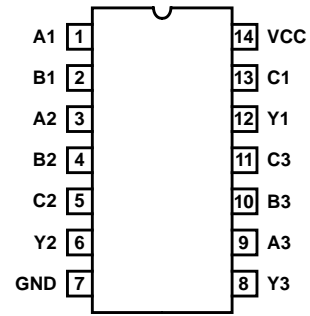
The Intersil HCTS11MS is a Radiation Hardened Triple 3-Input AND Gate. A high on all inputs forces the output to a High state.

The HCTS11MS utilizes advanced CMOS/SOS technology to achieve high-speed operation. This device is a member of radiation hardened, high-speed, CMOS/SOS Logic Family.

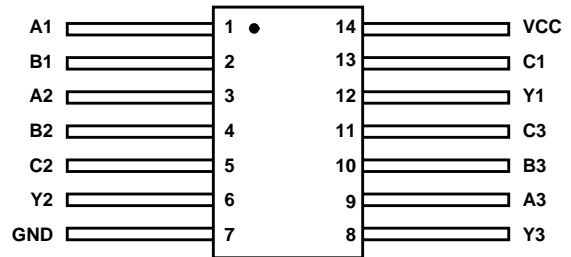
The HCTS11MS is supplied in a 14 lead Weld Seal Ceramic flatpack (K suffix) or a Weld Seal Ceramic Dual-In-Line Package (D suffix).

Pinouts

14 PIN CERAMIC DUAL-IN-LINE
MIL-STD-1835 DESIGNATOR CDIP2-T14, LEAD FINISH C
TOP VIEW



14 PIN CERAMIC FLAT PACK
MIL-STD-1835 DESIGNATOR CDFP3-F14, LEAD FINISH C
TOP VIEW

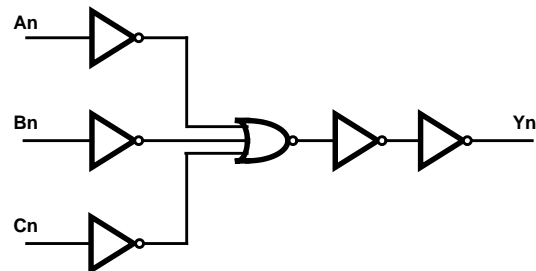


Truth Table

INPUTS			OUTPUTS
An	Bn	Cn	Yn
L	L	L	L
L	L	H	L
L	H	L	L
L	H	H	L
H	L	L	L
H	L	H	L
H	H	L	L
H	H	H	H

NOTE: L = Logic Level Low, H = Logic level High

Functional Diagram



Specifications HCTS11MS

Absolute Maximum Ratings

Supply Voltage	-0.5V to 7.0V
Input Voltage Range, All Inputs	-0.5V to VCC +0.5V
DC Input Current, Any One Input	±10mA
DC Drain Current, Any One Output	±25mA
(All Voltage Reference to the VSS Terminal)	
Storage Temperature Range (TSTG)	-65°C to +150°C
Lead Temperature (Soldering 10sec)	+265°C
Junction Temperature (TJ)	+175°C
ESD Classification	Class 1

Reliability Information

Thermal Impedance	θ_{ja}	θ_{jc}
Weld Seal DIC	75°C/W	16°C/W
Weld Seal Flat Pack	64°C/W	12°C/W
Power Dissipation per Package (PD)		
For T _A = -55°C to +100°C	1W	
For T _A = +100°C to +125°C	Derate Linearly at 13mW/°C	

CAUTION: As with all semiconductors, stress listed under "Absolute Maximum Ratings" may be applied to devices (one at a time) without resulting in permanent damage. This is a stress rating only. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. The conditions listed under "Electrical Performance Characteristics" are the only conditions recommended for satisfactory device operation.

Operating Conditions

Supply Voltage (VCC)	+4.5V to +5.5V	Input Low Voltage (VIL)	0.0V to 0.8V
Input Rise and Fall Times at 4.5V VCC (TR, TF)	100ns/V Max.	Input High Voltage (VIH)	VCC/2 to VCC
Operating Temperature Range (T _A)	-55°C to +125°C		

TABLE 1. DC ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETERS	SYMBOL	(NOTE 1) CONDITIONS	GROUP A SUB- GROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Quiescent Current	ICC	VCC = 5.5V, VIN = VCC or GND	1	+25°C	-	10	μA
			2, 3	+125°C, -55°C	-	200	μA
Output Current (Sink)	IOL	VCC = 4.5V, VIH = 4.5V, VOUT = 0.4V, VIL = 0V	1	+25°C	4.8	-	mA
			2, 3	+125°C, -55°C	4.0	-	mA
Output Current (Source)	IOH	VCC = 4.5V, VIH = 4.5V, VOUT = VCC -0.4V, VIL = 0V	1	+25°C	-4.8	-	mA
			2, 3	+125°C, -55°C	-4.0	-	mA
Output Voltage Low	VOL	VCC = 4.5V, VIH = 2.25V, IOL = 50μA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	-	0.1	V
		VCC = 5.5V, VIH = 2.75V, IOL = 50μA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	-	0.1	V
Output Voltage High	VOH	VCC = 4.5V, VIH = 2.25V, IOH = -50μA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	VCC -0.1	-	V
		VCC = 5.5V, VIH = 2.75V, IOH = -50μA, VIL = 0.8V	1, 2, 3	+25°C, +125°C, -55°C	VCC -0.1	-	V
Input Leakage Current	IIN	VCC = 5.5V, VIN = VCC or GND	1	+25°C	-0.5	+0.5	μA
			2, 3	+125°C, -55°C	-5.0	+5.0	μA
Noise Immunity Functional Test	FN	VCC = 4.5V, VIH = 2.25V, VIL = 0.8V (Note 2)	7, 8A, 8B	+25°C, +125°C, -55°C	4.0	0.5	-

NOTE:

1. All voltages reference to device GND.
2. For functional tests VO ≥ 4.0V is recognized as a logic "1", and VO ≤ 0.5V is recognized as a logic "0".

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TABLE 2. AC ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETER	SYMBOL	(NOTES 1, 2) CONDITIONS	GROUP A SUB- GROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Input to Output	TPHL	VCC = 4.5V	9	+25°C	2	18	ns
			10, 11	+125°C, -55°C	2	20	ns
	TPLH	VCC = 4.5V	9	+25°C	2	20	ns
			10, 11	+125°C, -55°C	2	22	ns

NOTES:

- All voltages referenced to device GND.
- AC measurements assume $R_L = 500\Omega$, $C_L = 50\text{pF}$, Input $t_r = t_f = 3\text{ns}$, $V_{IL} = \text{GND}$, $V_{IH} = 3\text{V}$.

TABLE 3. ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Capacitance Power Dissipation	CPD	VCC = 5.0V, f = 1MHz	1	+25°C	Typical 26		pF
			1	+125°C	Typical 56		pF
Input Capacitance	CIN	VCC = Open, f = 1MHz	1	+25°C	-	10	pF
			1	+125°C	-	10	pF
Output Transition Time	TTHL TTLH	VCC = 4.5V	1	+25°C	-	15	ns
			1	+125°C	-	22	ns

NOTES:

- The parameters listed in Table 3 are controlled via design or process parameters. Min and Max Limits are guaranteed but not directly tested. These parameters are characterized upon initial design release and upon design changes which affect these characteristics.

TABLE 4. DC POST RADIATION ELECTRICAL PERFORMANCE CHARACTERISTICS

PARAMETERS	SYMBOL	(NOTES 1, 2) CONDITIONS	TEMP- ERATURE	200K RAD LIMITS		1M RAD LIMITS		UNITS
				MIN	MAX	MIN	MAX	
Quiescent Current	ICC	VCC = 5.5V, VIN = VCC or GND	+25°C	-	0.2	-	1.0	mA
Output Current (Sink)	IOL	VCC = 4.5V, VIN = VCC or GND, VOUT = 0.4V	+25°C	4.0	-	4.0	-	mA
Output Current (Source)	IOH	VCC = 4.5V, VIN = VCC or GND, VOUT = VCC - 0.4V	+25°C	-4.0	-	-4.0	-	mA
Output Voltage Low	VOL	VCC = 4.5V and 5.5V, VIH = VCC/2, VIL = 0.8V at 200K RAD, VIL = 0.3V at 1M RAD, IOL = 50μA	+25°C	-	0.1	-	0.1	V
Output Voltage High	VOH	VCC = 4.5V and 5.5V, VIH = VCC/2, VIL = 0.8V at 200K RAD, VIL = 0.3V at 1M RAD, IOH = -50μA	+25°C	VCC - 0.1	-	VCC - 0.1	-	V
Input Leakage Current	IIN	VCC = 5.5V, VIN = VCC or GND	+25°C	-	±5	-	±5	μA
Noise Immunity Functional Test	FN	VCC = 4.5V, VIH = 2.25V, VIL = 0.8V at 200K RAD, VIL = 0.3V at 1M RAD (Note 3)	+25°C	-	-	-	-	-

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TABLE 4. DC POST RADIATION ELECTRICAL PERFORMANCE CHARACTERISTICS (Continued)

PARAMETERS	SYMBOL	(NOTES 1, 2) CONDITIONS	TEMP- ERATURE	200K RAD LIMITS		1M RAD LIMITS		UNITS
				MIN	MAX	MIN	MAX	
Input to Output	TPHL	VCC = 4.5V	+25°C	2	20	2	25	ns
	TPLH		+25°C	2	22	2	26	ns

NOTES:

1. All voltages referenced to device GND.
2. AC measurements assume RL = 500Ω, CL = 50pF, Input tr = tf = 3ns, VIL = GND, VIH = 3V.
3. For functional tests VO ≥ 4.0V is recognized as a logic "1", and VO ≤ 0.5V is recognized as a logic "0".

TABLE 5. BURN-IN AND OPERATING LIFE TEST, DELTA PARAMETERS (+25°C)

PARAMETER	GROUP B SUBGROUP	DELTA LIMIT
ICC	5	3μA
IOL/IOH	5	-15% of 0 Hour

TABLE 6. APPLICABLE SUBGROUPS

CONFORMANCE GROUPS	METHOD	GROUP A SUBGROUPS	READ AND RECORD
Initial Test (Preburn-In)	100%/5004	1, 7, 9	ICC, IOL/H
Interim Test I (Postburn-In)	100%/5004	1, 7, 9	ICC, IOL/H
Interim Test II (Postburn-In)	100%/5004	1, 7, 9	ICC, IOL/H
PDA	100%/5004	1, 7, 9, Deltas	
Interim Test III (Postburn-In)	100%/5004	1, 7, 9	ICC, IOL/H
PDA	100%/5004	1, 7, 9, Deltas	
Final Test	100%/5004	2, 3, 8A, 8B, 10, 11	
Group A (Note 1)	Sample/5005	1, 2, 3, 7, 8A, 8B, 9, 10, 11	
Group B	Subgroup B-5	1, 2, 3, 7, 8A, 8B, 9, 10, 11, Deltas	Subgroups 1, 2, 3, 9, 10, 11
	Subgroup B-6	1, 7, 9	
Group D	Sample/5005	1, 2, 3, 7, 8A, 8B, 9, 10, 11	

NOTE:

1. Alternate Group A in accordance with method 5005 of MIL-STD-883 may be exercised.

TABLE 7. TOTAL DOSE IRRADIATION

CONFORMANCE GROUPS	METHOD	TEST		READ AND RECORD	
		PRE RAD	POST RAD	PRE RAD	POST RAD
Group E Subgroup 2	5005	1, 7, 9	Table 4	1, 9	Table 4 (Note 1)

NOTE:

1. Except FN test which will be performed 100% Go/No-Go.

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TABLE 8. STATIC AND DYNAMIC BURN-IN TEST CONNECTIONS

OPEN	GROUND	1/2 VCC = 3V ± 0.5V	VCC = 6V ± 0.5V	OSCILLATOR	
				50kHz	25kHz
STATIC BURN-IN I TEST CONDITIONS (Note 1)					
6, 8, 12	1, 2, 3, 4, 5, 7, 9, 10, 11, 13	-	14	-	-
STATIC BURN-IN II TEST CONDITIONS (Note 1)					
6, 8, 12	7	-	1, 2, 3, 4, 5, 9, 10, 11, 13, 14	-	-
DYNAMIC BURN-IN TEST CONDITIONS (Note 2)					
-	7	6, 8, 12	14	1, 2, 3, 4, 5, 9, 10, 11, 13	-

NOTE:

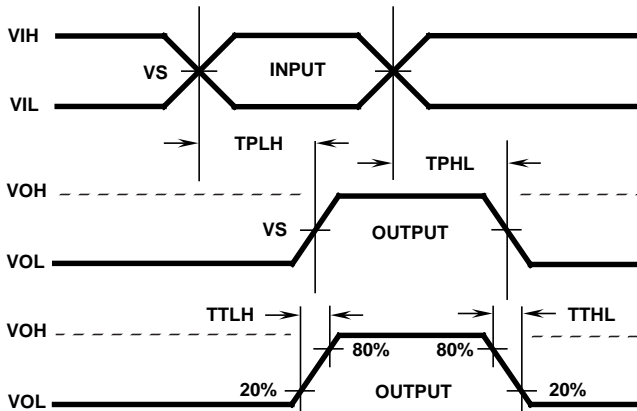
1. Each pin except VCC and GND will have a resistor of 10KΩ ± 5% for static burn-in
2. Each pin except VCC and GND will have a resistor of 1KΩ ± 5% for dynamic burn-in

TABLE 9. IRRADIATION TEST CONNECTIONS

OPEN	GROUND	VCC = 5V ± 0.5V
6, 8, 12	7	1, 2, 3, 4, 5, 9, 10, 11, 13, 14

NOTE: Each pin except VCC and GND will have a resistor of 47KΩ ± 5% for irradiation testing.
Group E, Subgroup 2, sample size is 4 dice/wafer 0 failures.

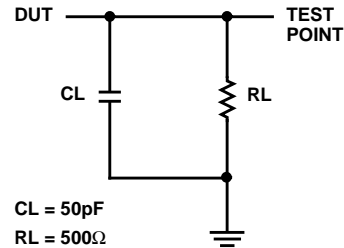
AC Timing Diagrams



AC VOLTAGE LEVELS

PARAMETER	HCTS	UNITS
VCC	4.50	V
VIH	3.00	V
VS	1.30	V
VIL	0	V
GND	0	V

AC Load Circuit



HCTS11MS

Die Characteristics

DIE DIMENSIONS:

87 x 88 mils
2.20 x 2.24mm

METALLIZATION:

Type: SiAl
Metal Thickness: $11\text{k}\text{\AA} \pm 1\text{k}\text{\AA}$

GLASSIVATION:

Type: SiO_2
Thickness: $13\text{k}\text{\AA} \pm 2.6\text{k}\text{\AA}$

DIE ATTACH:

Material: Silver Epoxy

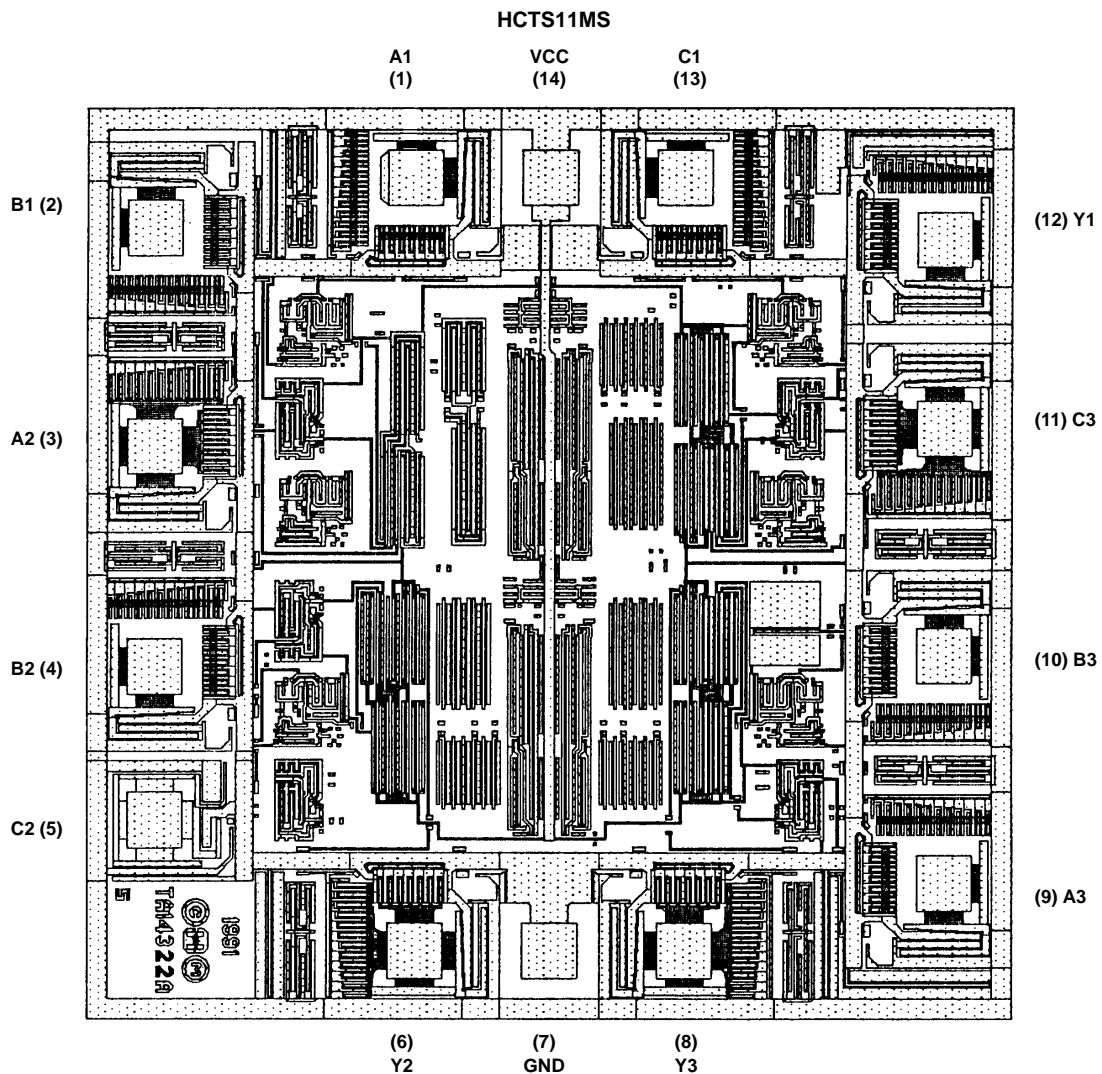
WORST CASE CURRENT DENSITY:

$<2.0 \times 10^5 \text{A/cm}^2$

BOND PAD SIZE:

$100\mu\text{m} \times 100\mu\text{m}$
4 mils x 4 mils

Metallization Mask Layout



HCTS11MS

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